- For Use in High-Speed Wallace-Tree Summing Networks

- High-Speed, High-Fan-Out Darlington Outputs

- Input Clamping Diodes Simplify System Design

TYPES	TYPICAL AVERAGE PROPAGATION DELAY TIME	TYPICAL POWER DISSIPATION
'LS183	15 ns	23 mW per bit

description

These dual full adders feature an individual carry output from each bit for use in multiple-input, carry-save techniques to produce the true sum and true carry outputs with no more than two gate delays. The circuits utilize high-speed, high-fan-out, transistor-transistor logic (TTL), but are compatible with both DTL and TTL families. SN54LS183 is characterized for operation over the full military temperature range of −55°C to 125°C; SN74LS183 is characterized for operation from 0°C to 70°C.
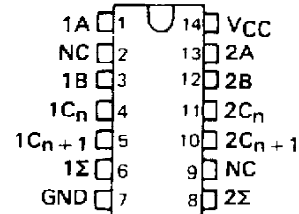
logic diagram (each adder)
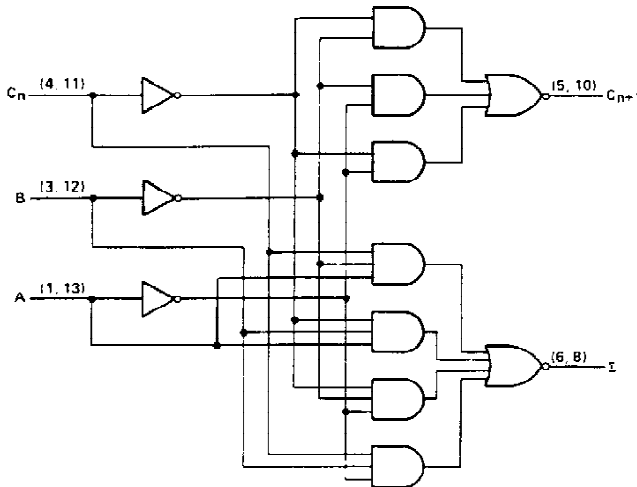
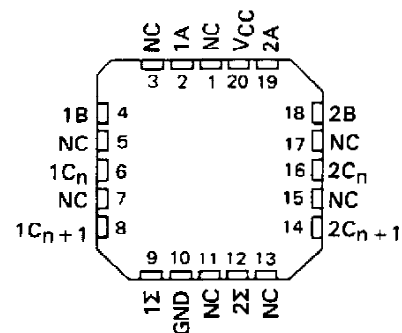Pin numbers shown are for D, J, N, and W packages.

SN54LS183 . . . J OR W PACKAGE
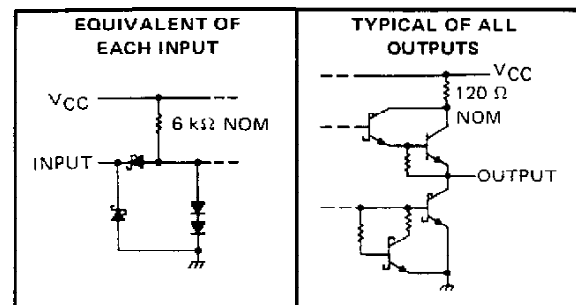SN74LS183 . . . D OR N PACKAGE
(TOP VIEW)

1A	1	14	VCC
NC	2	13	2A
1B	3	12	2B
1Cn	4	11	2Cn
1Cn+1	5	10	2Cn+1
1Σ	6	9	NC
GND	7	8	2Σ

SN54LS183 . . . FK PACKAGE
(TOP VIEW)

NC − No internal connection

FUNCTION TABLE
(EACH ADDER)

INPUTS			OUTPUTS	
C_n	B	A	Σ	C_{n+1}
L	L	L	L	L
L	L	H	H	L
L	H	L	H	L
L	H	H	L	H
H	L	L	H	L
H	L	H	L	H
H	H	L	L	H
H	H	H	H	H

H = high level, L = low level

schematics of inputs and outputs

EQUIVALENT OF EACH INPUT	TYPICAL OF ALL OUTPUTS
VCC 6 kΩ NOM INPUT	VCC 120 Ω NOM OUTPUT

TEXAS INSTRUMENTS

POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage V_{CC} (see Note 1) . . . . 7 V
Input voltage . . . . 7 V
Operating free-air temperature range: SN54LS183 Circuits . . . . −55°C to 125°C
SN74LS183 Circuits . . . . 0°C to 70°C
Storage temperature range . . . . −65°C to 150°C

NOTE 1: Voltage values, except interemitter voltage, are with respect to network ground terminal.

recommended operating conditions

	SN54LS183			SN74LS183			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			−400			−400	µA
Low-level output current, I_{OL}			4			8	mA
Operating free-air temperature, T_A	−55		125	0		70	°C

electrical characteristics over recommended operation free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
V_{IH}	High-level input voltage			2			2			V
V_{IL}	Low-level input voltage					0.7			0.8	V
V_{IK}	Input clamp voltage	V_{CC} = MIN,	I_I = −18 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage	V_{CC} = MIN, V_{IL} = V_{IL}max,	V_{IH} = 2 V, I_{OH} = −400 µA	2.5	3.4		2.7	3.4		V
V_{OL}	Low-level output voltage	V_{CC} = MIN, V_{IH} = 2 V,	I_{OL} = 4 mA		0.25	0.4		0.25	0.4	V
		V_{IL} = V_{IL}max,	I_{OL} = 8 mA					0.35	0.5	
I_I	Input current at maximum input voltage	V_{CC} = MAX,	V_I = 7 V			0.3			0.3	mA
I_{IH}	High-level input current	V_{CC} = MAX,	V_I = 2.7 V			60			60	µA
I_{IL}	Low-level input current	V_{CC} = MAX,	V_I = 0.4 V			−1.2			−1.2	mA
I_{OS}	Short-circuit output current§	V_{CC} = MAX		−20		−100	−20		−100	mA
I_{CCL}	Supply current, all outputs low	V_{CC} = MAX,	See Note 3		10	17		10	17	mA
I_{CCH}	Supply current, all outputs high	V_{CC} = MAX,	See Note 4		8	14		8	14	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.
NOTES: 3. I_{CCL} is measured with all outputs open and all inputs grounded.
4. I_{CCH} is measured with all outputs open and all inputs at 4.5 V.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output	C_L = 15 pF, R_L = 2 kΩ, See Note 5		9	15	ns
t_{PHL}	Propagation delay time, high-to-low-level output			20	33	ns

NOTE 5: Load circuits and voltage waveforms are shown in Section 1.

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